

**2.5V/3.3V, High Bandwidth, Hot Insertion, 4-Bit, 2-Port Bus Switch with Individual Enables**

**Features**

- Near-Zero propagation delay
- 5-ohm switches connect inputs to outputs
- High Bandwidth (>400 MHz)
- Rail-to-Rail, or 2.5V or 3.3V Switching
- 5V I/O Tolerant
- 2.5V Supply Voltage Operation
- Permits Hot Insertion
- Packaging (Pb-free & Green available):
  - 14-pin 150-mil wide plastic SOIC (W)
  - 14-pin 170-mil wide plastic TSSOP (L)
  - 16-pin 150-mil wide plastic QSOP (Q)

**Applications**

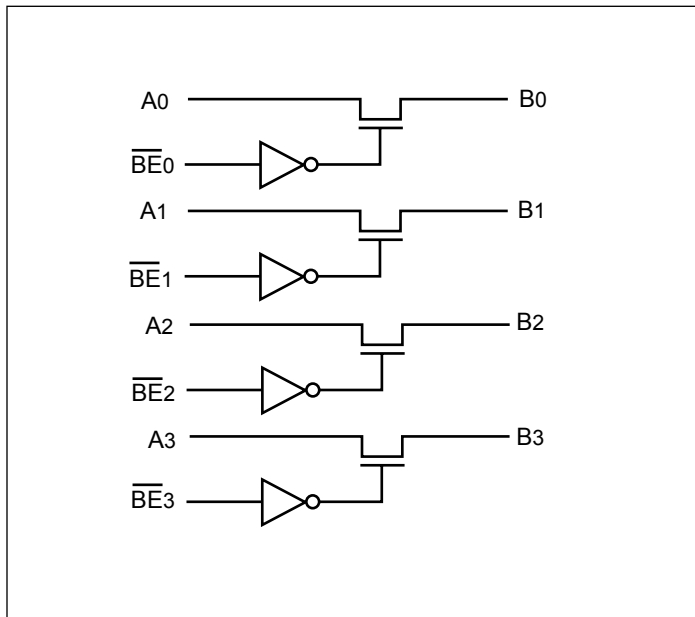
- High Bandwidth Data Switching
- Hot Docking

**Description**

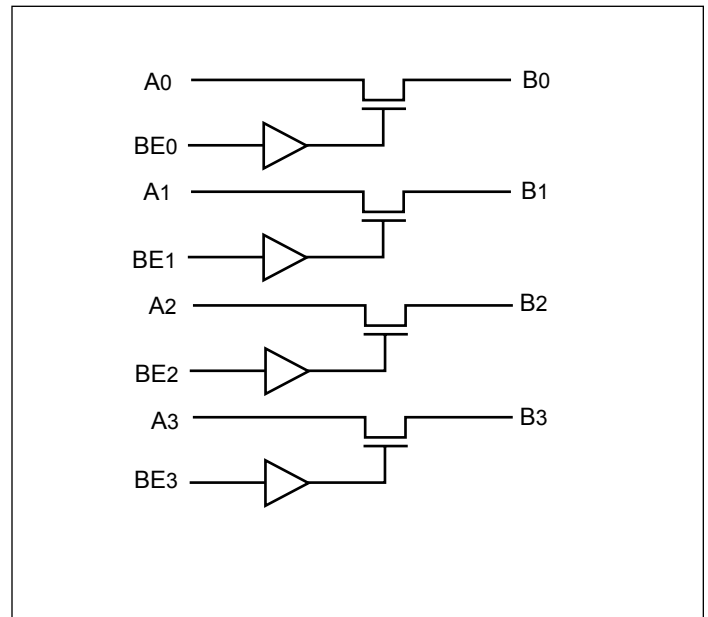
Diodes' PI3C3125 and PI3C3126 are 2.5 volt or 3.3 volt, 4-bit bus switches designed with four individual 5-ohm bus switches with fast individual enables in an industry standard 74XX125/126 pinout. When enabled via the associated Bus Enable pin, the "A" pin is directly connected to the "B" pin for that particular gate. The bus switch introduces no additional propagation delay or additional ground bounce noise.

The PI3C3125 device has active LOW enables, and the PI3C3126 has active HIGH enables. It is very useful in switching signals that have high bandwidth (>400 MHz).

**PI3C3125 Block Diagram**



**PI3C3126 Block Diagram**



**PI3C3125/PI3C3126**

**Maximum Ratings**

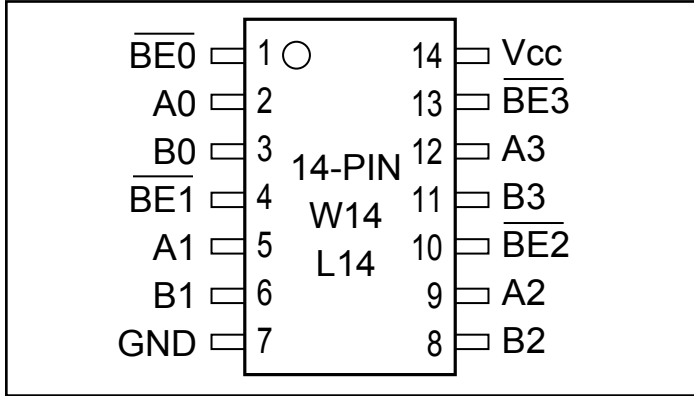
(Above which the useful life may be impaired. For user guidelines, not tested.)

Storage Temperature .....	-65°C to +150°C
Ambient Temperature with Power Applied .....	-40°C to +85°C
Supply Voltage to Ground Potential (Inputs & V <sub>CC</sub> Only).....	-0.5V to +4.6V
Supply Voltage to Ground Potential (Outputs & D/O Only) ..	-0.5V to +4.6V
DC Input Voltage .....	-0.5V to +5.5V
DC Output Current.....	120mA
Junction Temperature.....	125°C

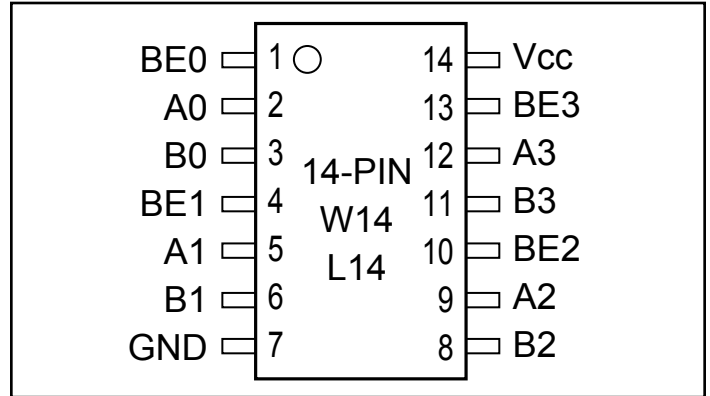
**Note:**

Stresses greater than those listed under MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

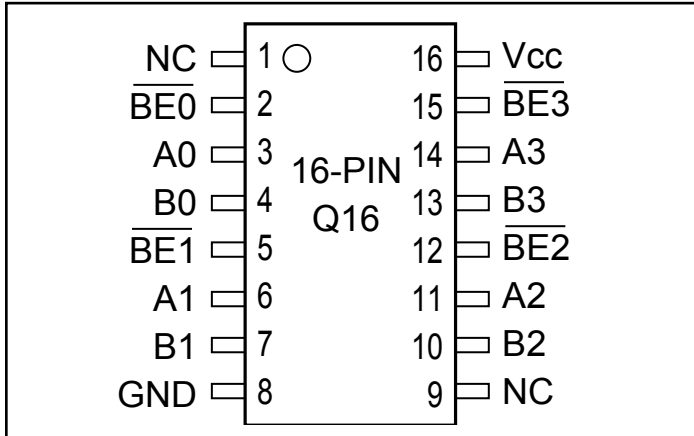
**PI3C3125 14-Pin Configuration**



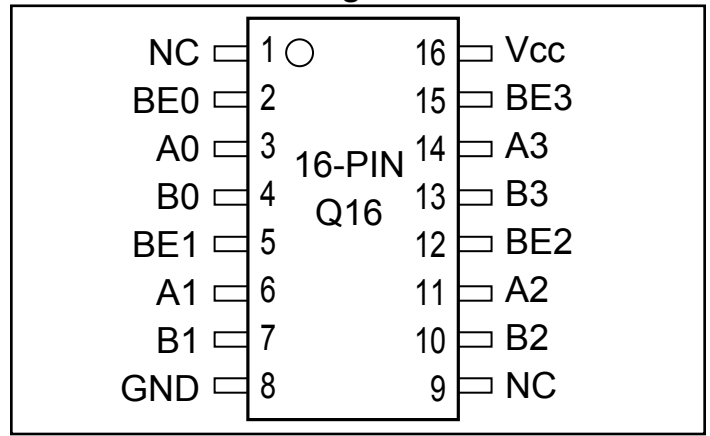
**PI3C3126 14-Pin Configuration**



**PI3C3125 16-Pin Configuration**



**PI3C3126 16-Pin Configuration**



**Pin Description**

Pin Name	Description
$\overline{BE}_n$	Switch Enable (PI3C3125)
BE <sub>n</sub>	Switch Enable (PI3C3126)
A3 - A0	Bus A
B3 - B0	Bus B
V <sub>CC</sub>	Power
GND	Ground

**Truth Table<sup>(1)</sup>**

PI3C3125 $\overline{BE}_n$	PI3C3126 BE <sub>n</sub>	A <sub>n</sub>	B <sub>n</sub>	V <sub>CC</sub>	Function
X*	X	Hi-Z	Hi-Z	GND	Disconnect
H	L	Hi-Z	Hi-Z	V <sub>CC</sub>	Disconnect
L	H	B <sub>n</sub>	A <sub>n</sub>	V <sub>CC</sub>	Disconnect

**Note:**

1. H = High Voltage Level, L = Low Voltage Level

Hi-Z = High Impedance, X = Don't Care

\* A pull-up resistor should be provided for power-up protection.

**DC Electrical Characteristics** (Over Operating Range,  $T_A = -40^\circ\text{C}$  to  $+85^\circ\text{C}$ ,  $V_{CC} = 3.3\text{V} \pm 10\%$ )

Parameters	Description	Test Conditions <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max	Units
$V_{IH}$	Input HIGH Voltage	Guaranteed Logic HIGH Level	2.0			V
$V_{IL}$	Input LOW Voltage	Guaranteed Logic LOW Level -0.5		0.8		
$I_{IH}$	Input HIGH current	$V_{CC} = \text{Max.}, V_{IN} = V_{CC}$			$\pm 1$	$\mu\text{A}$
$I_{IL}$	Input LOW Current	$V_{CC} = \text{Max.}, V_{IN} = \text{GND}$			$\pm 1$	$\mu\text{A}$
$I_{OZH}^{(3)}$	High Impedance Output Current	$0 \leq A, B \leq V_{CC}$			$\pm 1$	
$V_{IK}$	Clamp Diode Voltage	$V_{CC} = \text{Min.}, I_{IN} = -18\text{mA}$		-0.73	-1.2	V
$R_{ON}$	Switch ON Resistance <sup>(4)</sup>	$V_{CC} = \text{Min.}, V_{IN} = 0.0\text{V}, I_{ON} = 48\text{mA}$ or $60\text{mA}$ $V_{CC} = \text{Min.}, V_{IN} = 2.4\text{V}, I_{ON} = 15\text{mA}$		5 8	7 15	$\Omega$

**Notes:**

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device type.
- Typical values are at  $V_{CC} = 3.3\text{V}$ ,  $T_A = 25^\circ\text{C}$  ambient and maximum loading.
- Not more than one output should be shorted at one time. Duration of the test should not exceed one second.
- Measured by the voltage drop between A and B pin at indicated current through the switch. ON resistance is determined by the lower of the voltages on the two (A,B) pins.

**Capacitance** ( $T_A = 25^\circ\text{C}$ ,  $f = 1\text{MHz}$ )

Parameters <sup>(1)</sup>	Description	Test Conditions	Typ.	Units
$C_{IN}$	Input Capacitance	$V_{IN} = 0\text{V}$	3.5	pF
$C_{OFF}$	A/B Capacitance, Switch Off	$V_{IN} = 0\text{V}$	5.0	
$C_{ON}$	A/B Capacitance, Switch On	$V_{IN} = 0\text{V}$	10.0	

**Notes:**

- This parameter is determined by device characterization but is not production tested.

**Power Supply Characteristics**

Parameters	Description	Test Conditions		Min.	Typ. <sup>(2)</sup>	Max.	Units
$I_{CC}$	Quiescent Power Supply Current	$V_{CC} = \text{Max}$	$V_{IN} = \text{GND}$ or $V_{CC}$		260	500	$\mu\text{A}$
$\Delta I_{CC}$	Supply Current per Input HIGH	$V_{CC} = \text{Max}$	$V_{IN} = 3.0\text{V}^{(3)}$			750	

**Notes:**

- For Max. or Min. conditions, use appropriate value specified under Electrical Characteristics for the applicable device.
- Typical values are at  $V_{CC} = 3.3\text{V}$ ,  $+25^\circ\text{C}$  ambient.
- Per driven input (control input only); A and B pins do not contribute to  $\Delta I_{CC}$ .

**PI3C3125/PI3C3126**

**PI3C3125/PI3C3126 Switching Characteristics over 3.3V Operating Range**

Parameters	Description	Conditions	PI3C3125/PI3C3126		Units
			Com.		
			Min.	Max.	
t <sub>PLH</sub> t <sub>PHL</sub>	Propogation Delay <sup>(1,2)</sup> A to B, B to A	C <sub>L</sub> = 50pF R <sub>L</sub> = 500Ω		0.25	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Bus Enable Time	C <sub>L</sub> = 50pF R <sub>L</sub> = 500Ω	1.5	6.5	
t <sub>PHZ</sub> t <sub>PLZ</sub>	Bus Disable Time	R = 500Ω	1.5	5.5	

**Notes:**

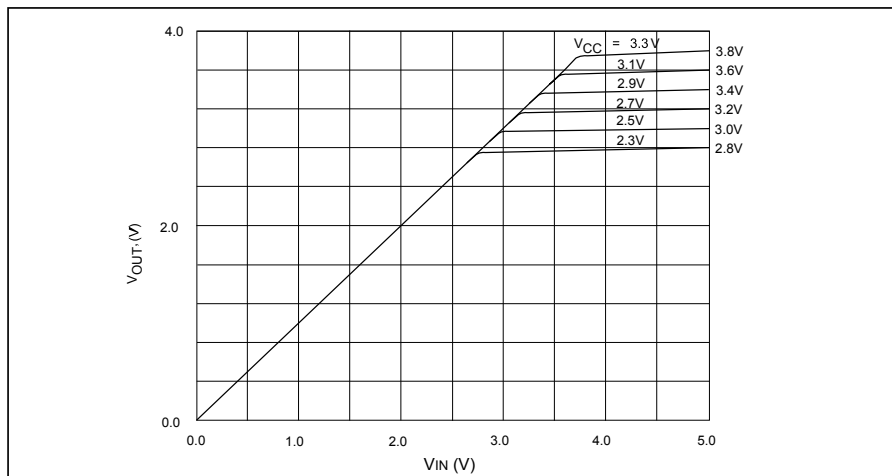
1. This parameter is guaranteed but not tested on Propagation Delays.
2. The bus switch contributes no propagational delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.

**PI3C3125/PI3C3126 Switching Characteristics over 2.5V Operating Range**

Parameters	Description	Conditions	PI3C3125/PI3C3126		Units
			Com.		
			Min.	Max.	
t <sub>PLH</sub> t <sub>PHL</sub>	Propogation Delay <sup>(1,2)</sup> A to B, B to A	C <sub>L</sub> = 50pF R <sub>L</sub> = 500Ω		0.25	ns
t <sub>PZH</sub> t <sub>PZL</sub>	Bus Enable Time	C <sub>L</sub> = 50pF R <sub>L</sub> = 500Ω	1.5	9.8	
t <sub>PHZ</sub> t <sub>PLZ</sub>	Bus Disable Time	R = 500Ω	1.5	8.3	

**Notes:**

1. This parameter is guaranteed but not tested on Propagation Delays.
2. The bus switch contributes no propagational delay other than the RC delay of the ON resistance of the switch and the load capacitance. The time constant for the switch alone is of the order of 0.25ns for 50pF load. Since this time constant is much smaller than the rise/fall times of typical driving signals, it adds very little propagational delay to the system. Propagational delay of the bus switch when used in a system is determined by the driving circuit on the driving side of the switch and its interaction with the load on the driven side.



Switch Output Voltage vs. Input Voltage over Various Supply Voltages

**PI3C3125/PI3C3126**

**Packaging Mechanical: 14-SOIC (W)**

SYMBOLS	MIN.	NOM.	MAX.
A	—	—	1.75
A1	0.10	—	0.25
A2	1.25	—	—
b	0.31	—	0.51
c	0.10	—	0.25
D	8.55	8.65	8.75
E	5.80	6.00	6.20
E1	3.70	3.90	4.10
e	1.27 BSC		
L	0.40	—	1.27
L1	1.04 REF		
h	0.25	—	0.50
$\theta^\circ$	0	—	8

SEATING PLANE

GAUGE PLANE

SEATING PLANE

0.10 C

0.25

$\theta^\circ$

L

L1

PERICOM  
Enabling Serial Connectivity

DATE: 03/24/16

DESCRIPTION: 14-Pin, 150mil Wide SOIC

PACKAGE CODE: W (W14)

DOCUMENT CONTROL #: PD-1002

REVISION: E

NOTES:  
1. ALL DIMENSIONS ARE IN mm. ANGLES IN DEGREES.  
2. JEDEC MS-012  
3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

16-0055

**PI3C3125/PI3C3126**

**Packaging Mechanical: 14-TSSOP (L)**

SYMBOLS	MIN.	NOM.	MAX.
A	–	–	1.20
A1	0.05	–	0.15
A2	0.80	1.00	1.05
b	0.19	–	0.30
c	0.09	–	0.20
D	4.90	5.00	5.10
E1	4.30	4.40	4.50
E	6.20	6.40	6.60
[e]	0.65 BSC		
L1	1.00 REF		
L	0.45	0.60	0.75
S	0.20	–	–
θ	0°	–	8°

**NOTES:**  
 1. ALL DIMENSIONS IN MILLIMETERS. ANGLES IN DEGREES.  
 2. JEDEC MO-153F  
 3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

**PERICOM**  
Enabling Serial Connectivity

DATE: 03/24/16

DESCRIPTION: 14-Pin, 173mil Wide TSSOP

PACKAGE CODE: L (L14)

DOCUMENT CONTROL #: PD-1309

REVISION: E

16-0060

**PI3C3125/PI3C3126**

**Packaging Mechanical: 16-QSOP (Q)**

SYMBOLS	MIN.	NOM.	MAX.
A	—	—	0.069
A1	0.004	—	0.0098
A2	0.049	—	—
b	0.008	—	0.012
c	0.004	—	0.010
D	0.189	0.193	0.197
E1	0.150	0.154	0.158
E	0.228	0.236	0.244
L	0.016	—	0.050
L1	0.041 REF.		
e	0.025 BSC.		
$\theta^\circ$	0	—	8

UNIT : INCH

SEATING PLANE

GAUGE PLANE  
SEATING PLANE

DETAIL A

PERICOM<sup>®</sup>  
Enabling Serial Connectivity

DATE: 04/08/16

DESCRIPTION: 16-Pin, 150mil Wide QSOP

PACKAGE CODE: Q (Q16)

DOCUMENT CONTROL #: PD-1201

REVISION: H

NOTES:  
1. ALL DIMENSIONS IN INCH. ANGLES IN DEGREES.  
2. JEDEC MO-137E  
3. DIMENSIONS DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS.

16-0056

**For latest package info.**

please check: <http://www.diodes.com/design/support/packaging/pericom-packaging/packaging-mechanicals-and-thermal-characteristics/>

**Ordering Information**

Ordering Code	Packaging Code	Description
PI3C3125LEX	L	14-pin, 173mil Wide (TSSOP)
PI3C3125WEX	W	14-pin, 150mil Wide (SOIC)
PI3C3126LEX	L	14-pin, 173mil Wide (TSSOP)
PI3C3126QEX	Q	16-pin, 150mil Wide (QSOP)

**Notes:**

- Thermal characteristics can be found on the company web site at [www.diodes.com/design/support/packaging/](http://www.diodes.com/design/support/packaging/)
- E = Pb-free and Green
- X suffix = Tape/Reel

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# Mouser Electronics

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## Diodes Incorporated:

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[PI3C3125LE+DLX](#)

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- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
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- Поставку компонентов, требующих военную и космическую приемку.
- Входной контроль качества.
- Наличие сертификата ISO.

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- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
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